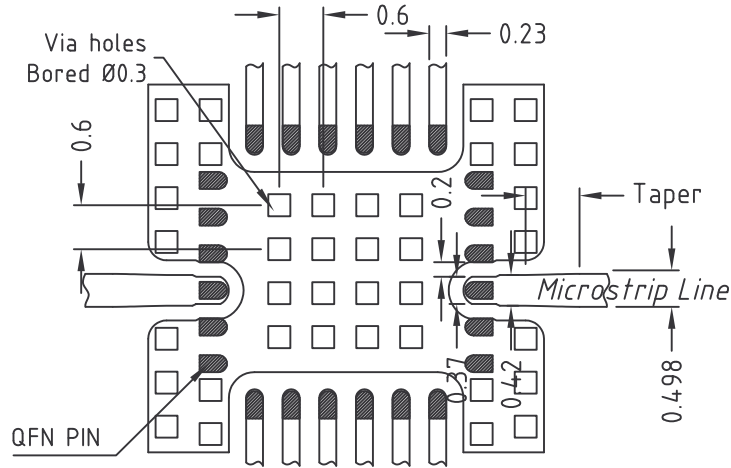


RECOMMENDED FOOTPRINT FOR 24L QFN4X4



Material : Ro4003 ROGERS

$\epsilon = 3.38$

Thickness = 203 μm (.008")

*This land pattern is used for UMS prototyping assembly.
For production, design must be adapted with regard to
PCB tolerances and assembly process.*

B	Ground Footprint Optimization – Vias holes pitch modification	Belloche	16/12/07
A	Add Ground Footprint – Add Microstrip Line – Add Material – Add QFN pins	Belloche	06/06/07
Rev.	Evolution	Name	Date

**united
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FOOTPRINT

Part number: 61 495 472	Type: 043
Designation: Recommended Footprint for 24L QFN4X4	Scale: 10:1
Name: Belloche	Rev.: B
Sheet: 01 of 01	Format: A4
Projection:	Date: 06/04/04